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**Zerebilov et al.**

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(54) **ELECTRICAL CABLE CONNECTOR**

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See application file for complete search history.

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(57) **CLAIM**

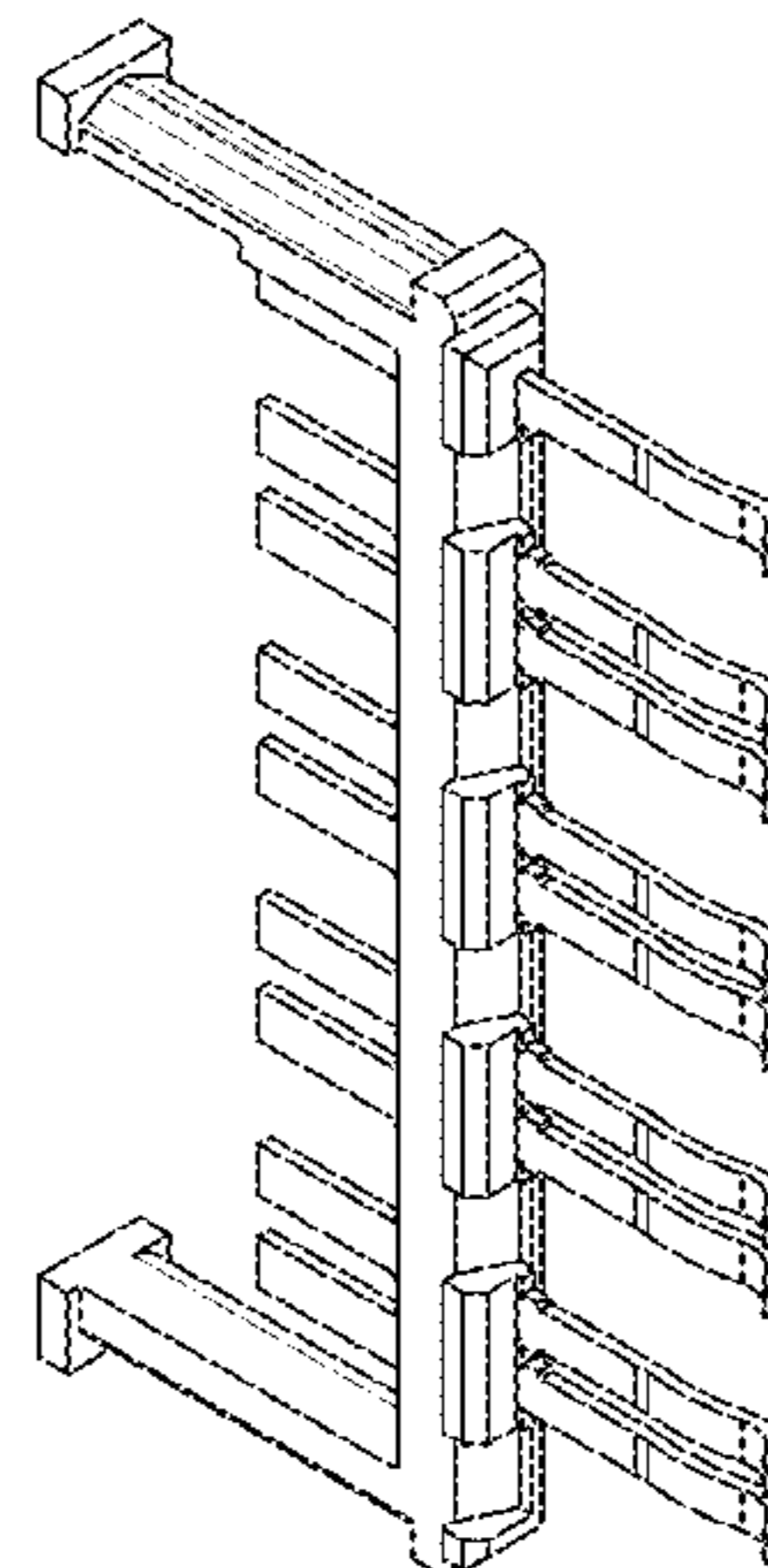
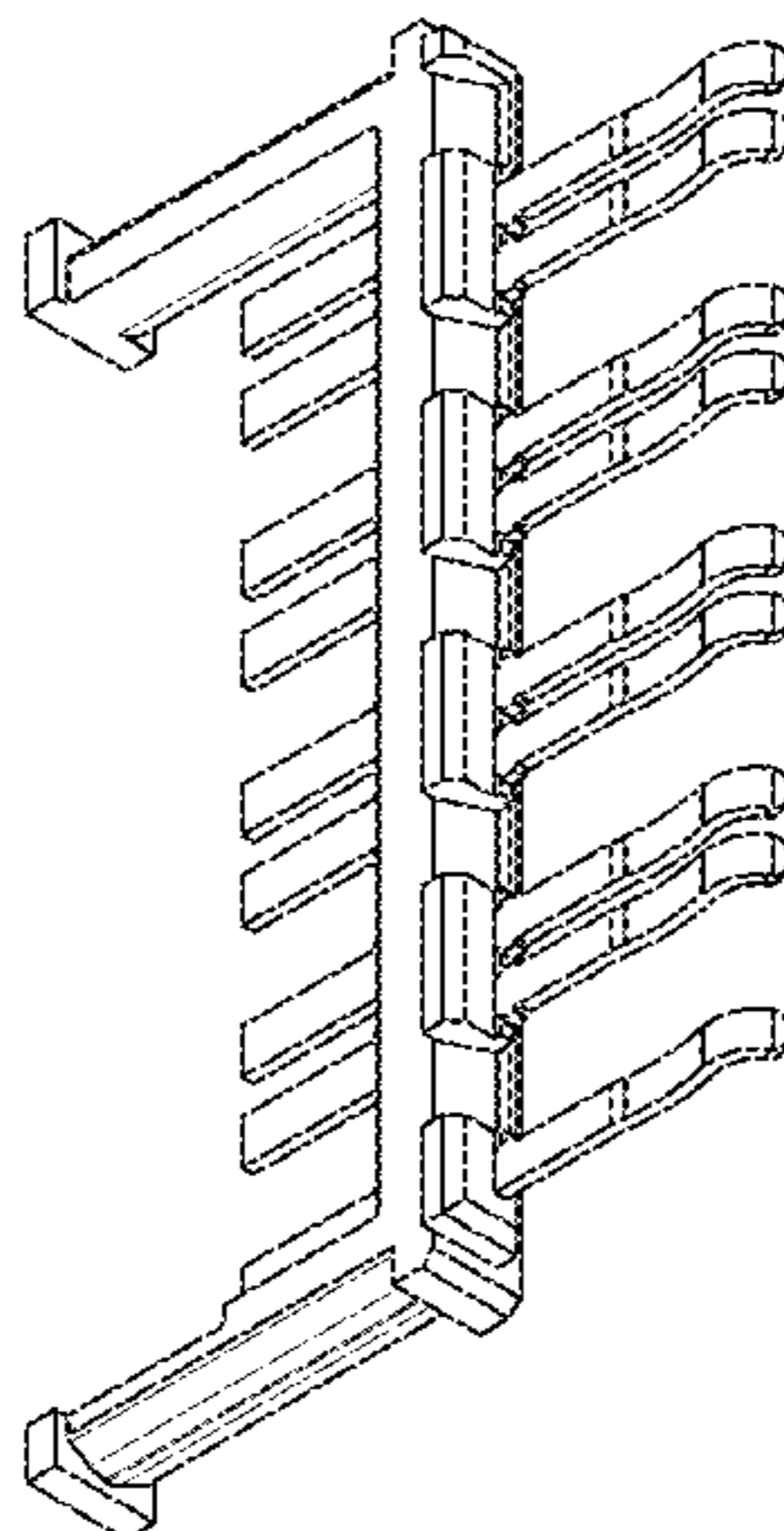
The ornamental design for an electrical cable connector, as shown and described.

**DESCRIPTION**

FIG. 1 is a top, right, front perspective view of a first embodiment of an electrical cable connector showing our design; FIG. 2 is a bottom, left, front perspective view thereof; FIG. 3 is a top, left, rear perspective view thereof; FIG. 4 is a bottom, left, rear perspective view thereof; FIG. 5 is a front elevation view thereof; FIG. 6 is a rear elevation view thereof; FIG. 7 is a top plan view thereof; FIG. 8 is a bottom plan view thereof; FIG. 9 is a left side elevation view thereof; FIG. 10 is a right side elevation view thereof; FIG. 11 is a top, left, front perspective view of a second embodiment of an electrical cable connector showing our new design; FIG. 12 is a top, right, rear perspective view thereof; FIG. 13 is a top, left, rear perspective view thereof; FIG. 14 is a bottom, right, rear perspective view thereof; FIG. 15 is a front elevation view thereof; FIG. 16 is a rear elevation view thereof; FIG. 17 is a top plan view thereof; FIG. 18 is a bottom plan view thereof; FIG. 19 is a left side elevation view thereof; and, FIG. 20 is a right side elevation view thereof.

In a preferred embodiment, the nature of this product is an electrical component that can take the form of an electrical cable connector, a leadframe assembly therefor, an electrical shield therefor, such as an electrical ground shield, a leadframe housing and electrical contacts therefor, and a connector housing therefor.

**1 Claim, 8 Drawing Sheets**



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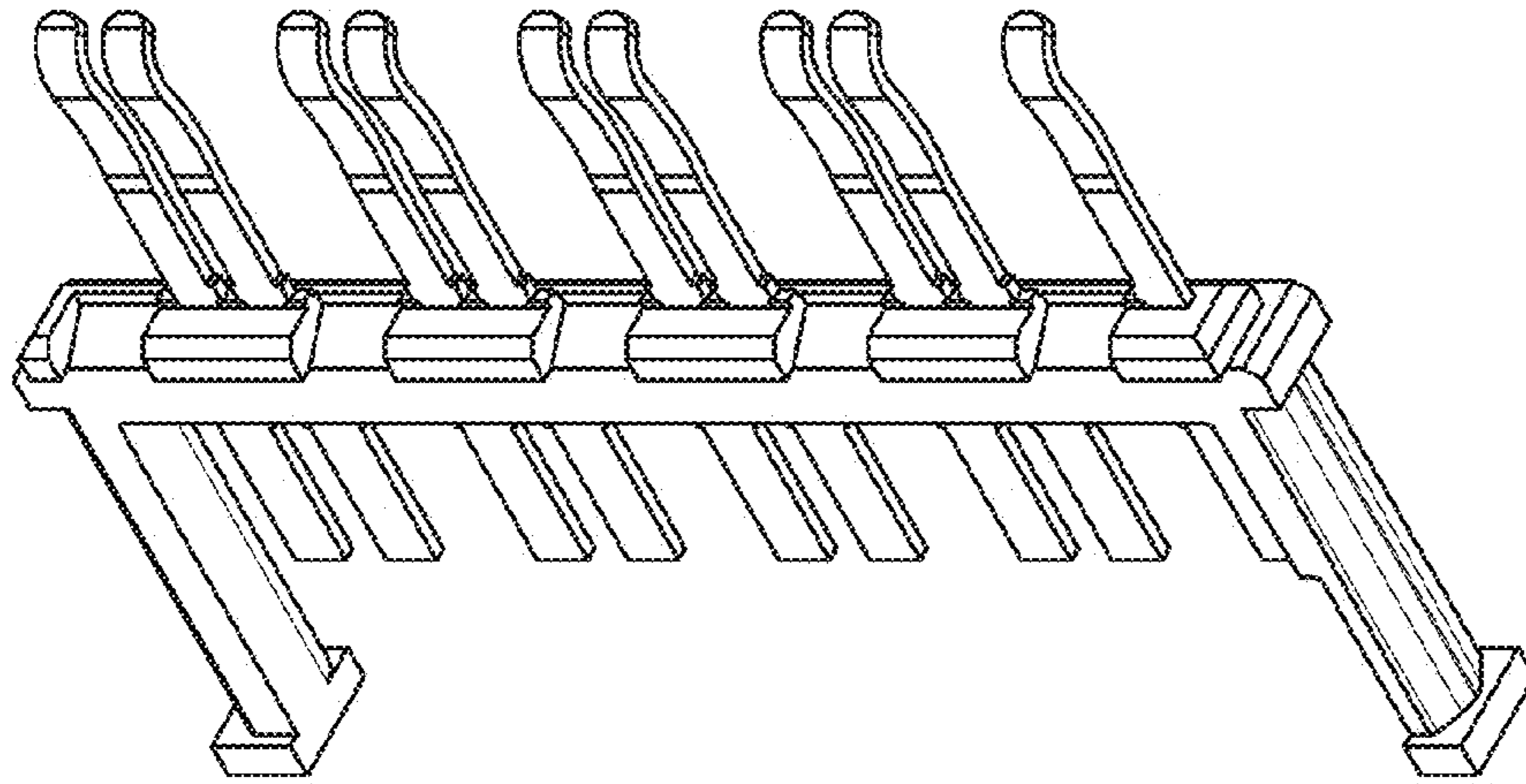


Fig. 2

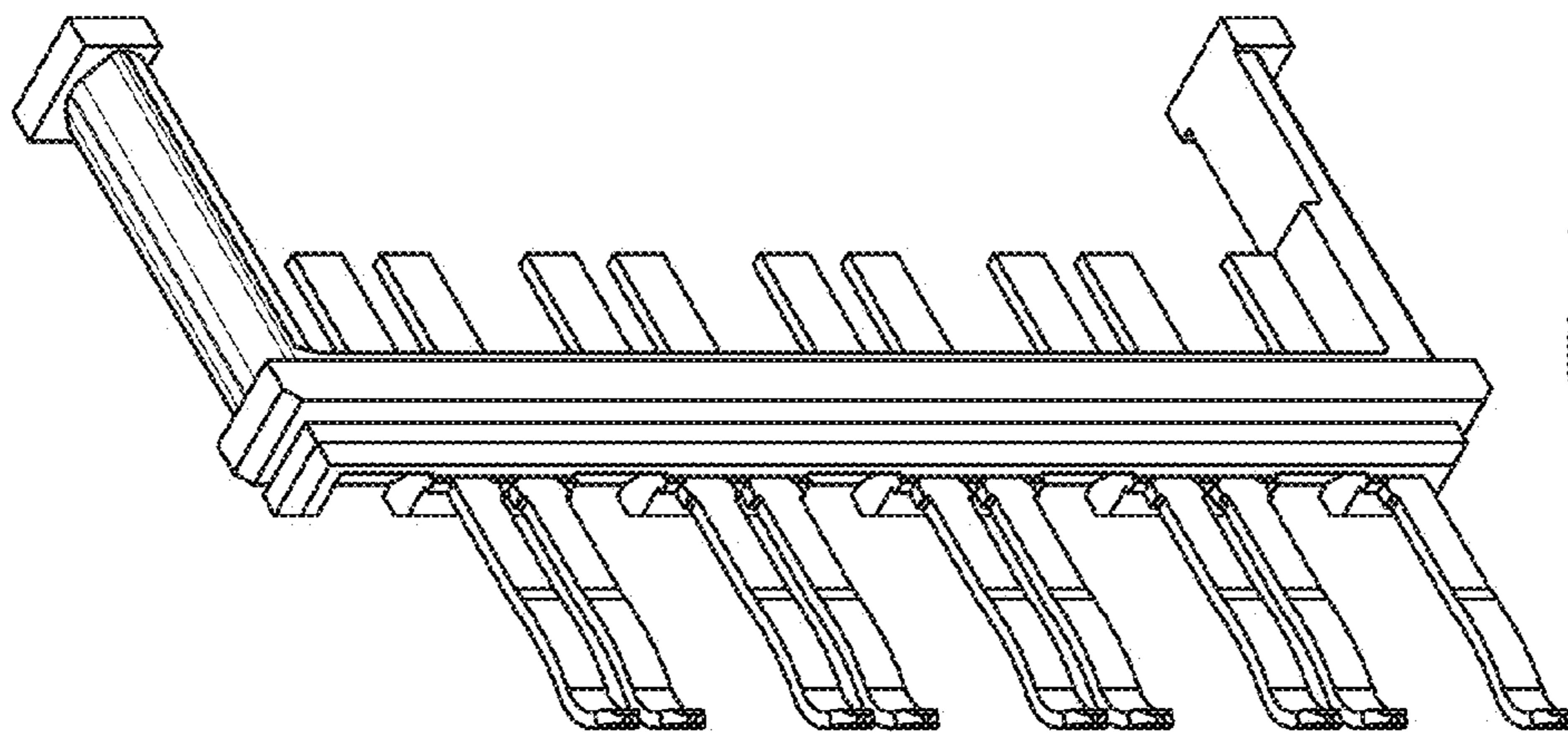


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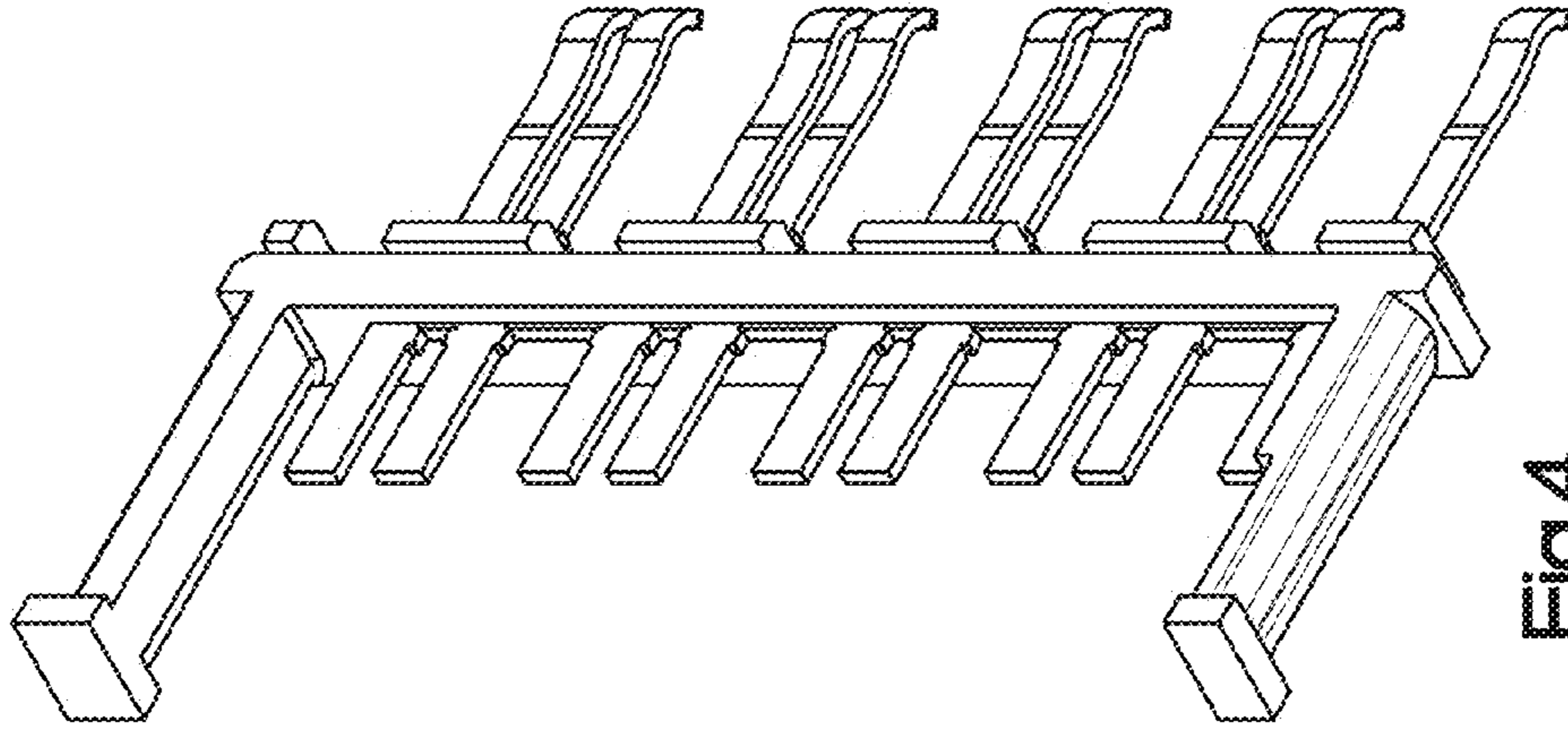


Fig. 4

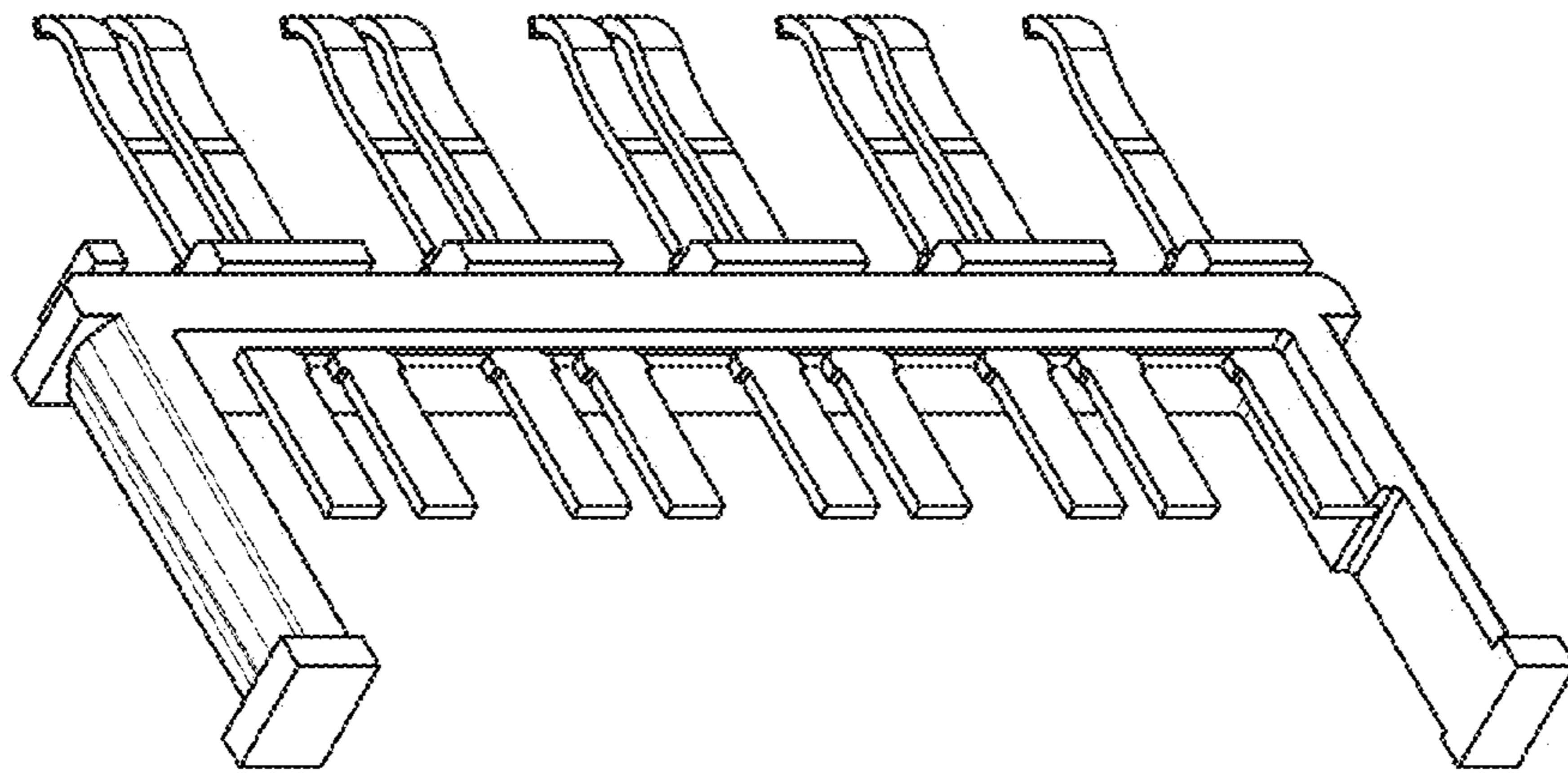


Fig. 3

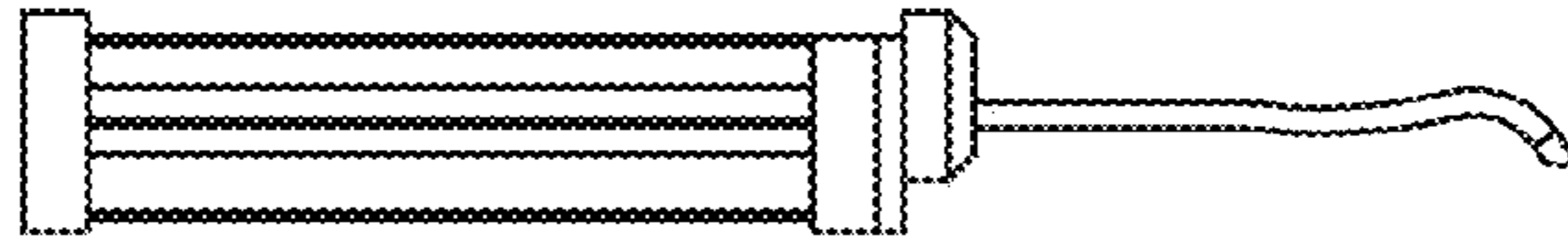


Fig. 8

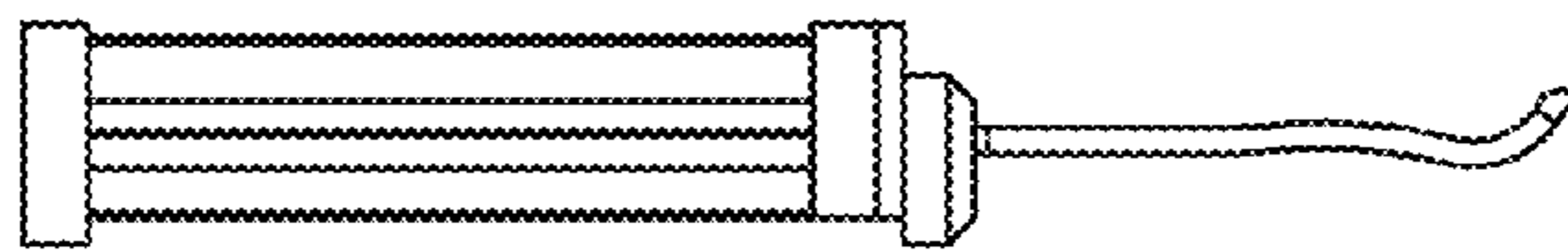


Fig. 7

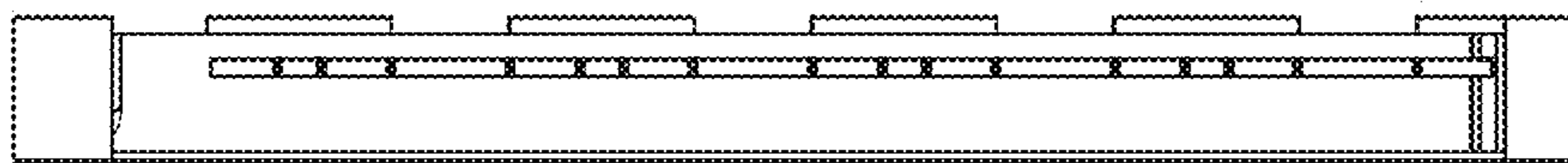


Fig. 6

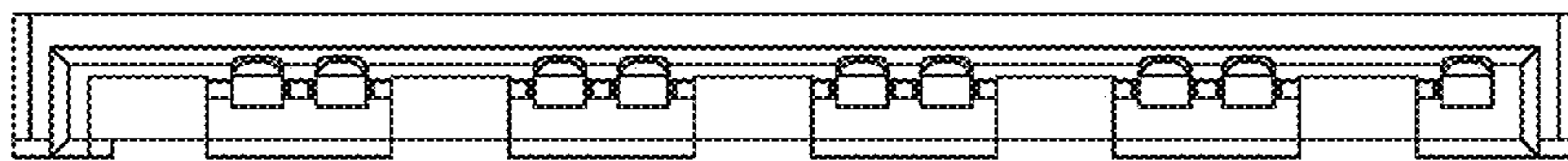


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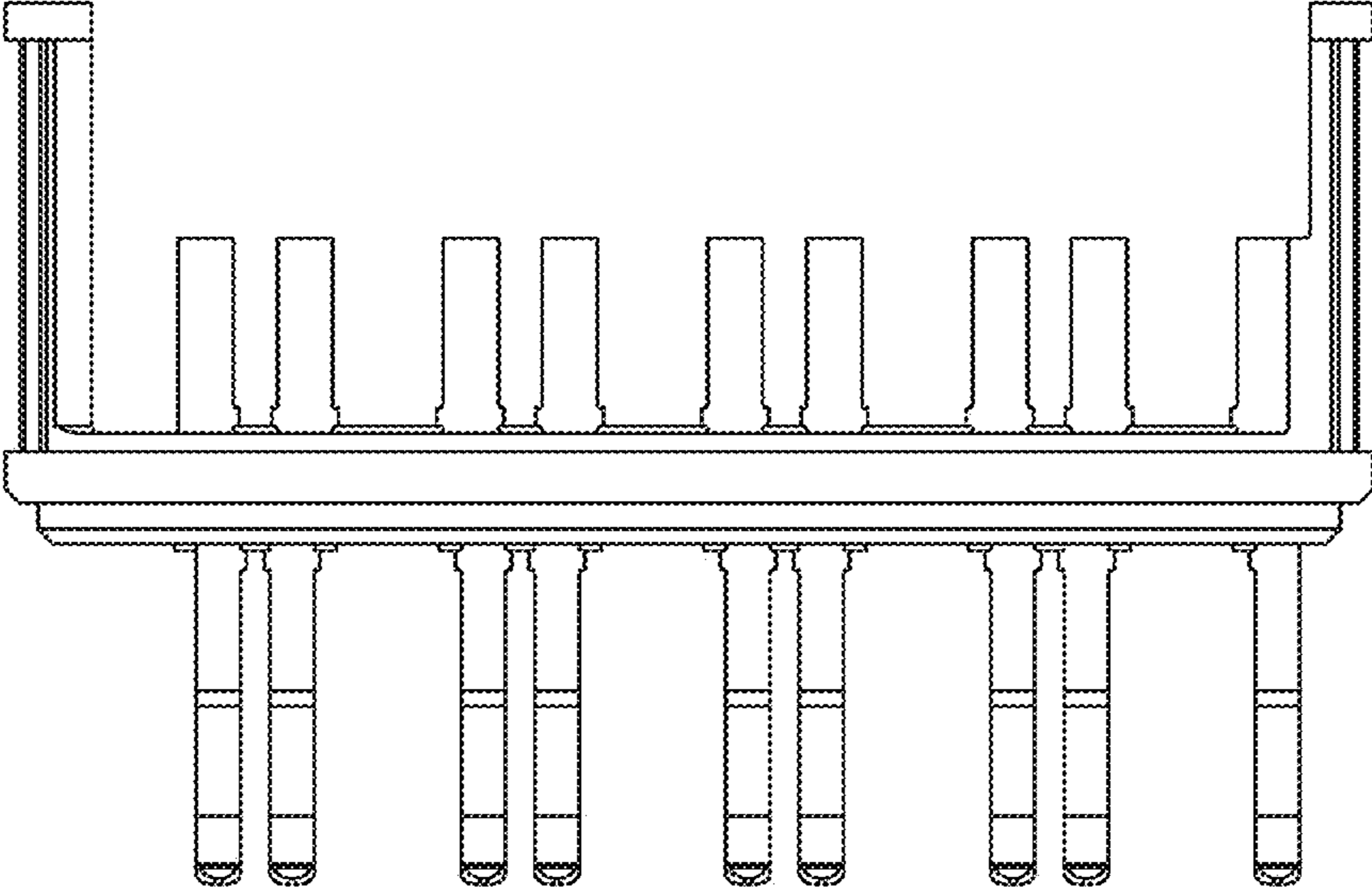


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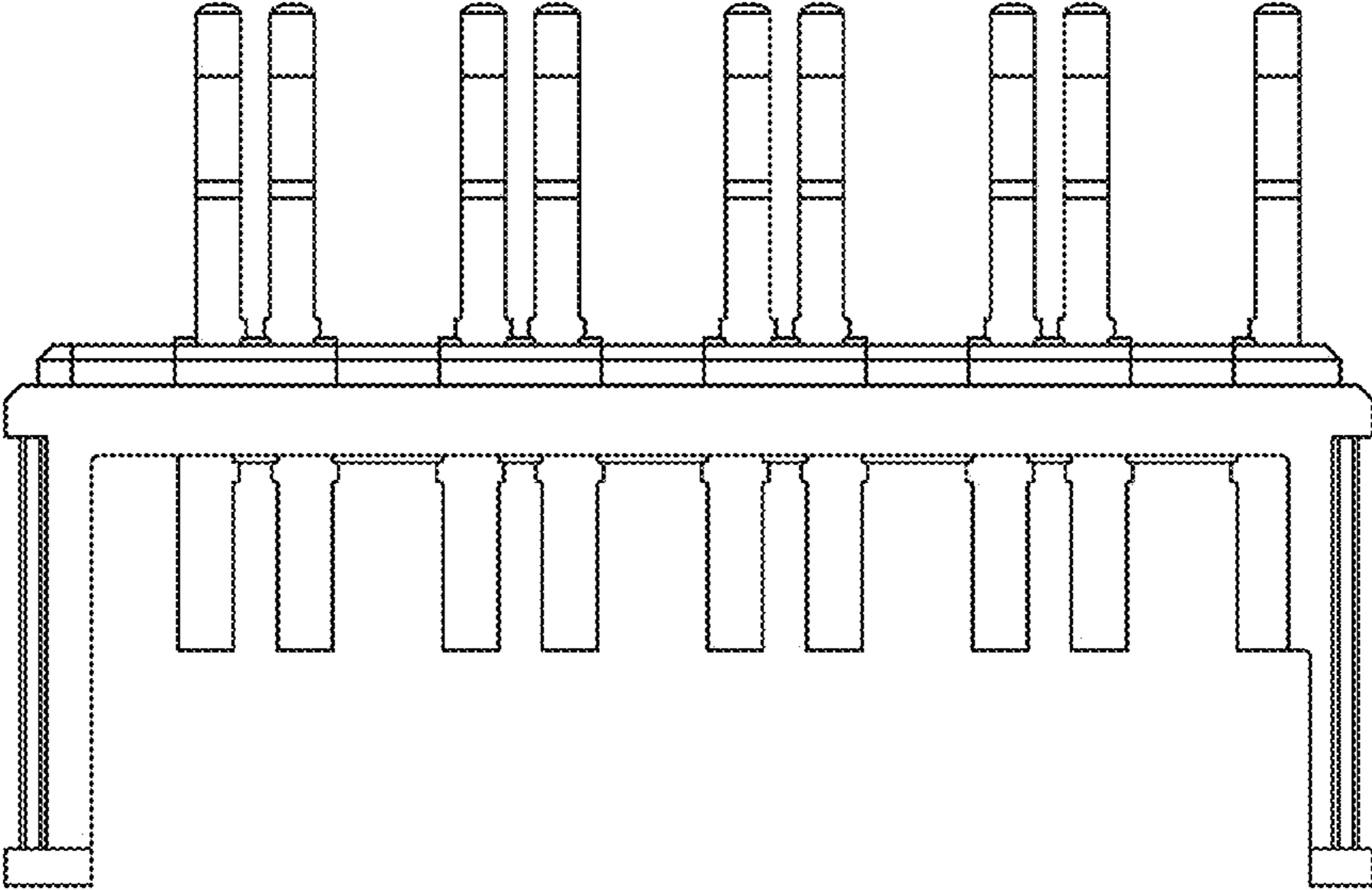


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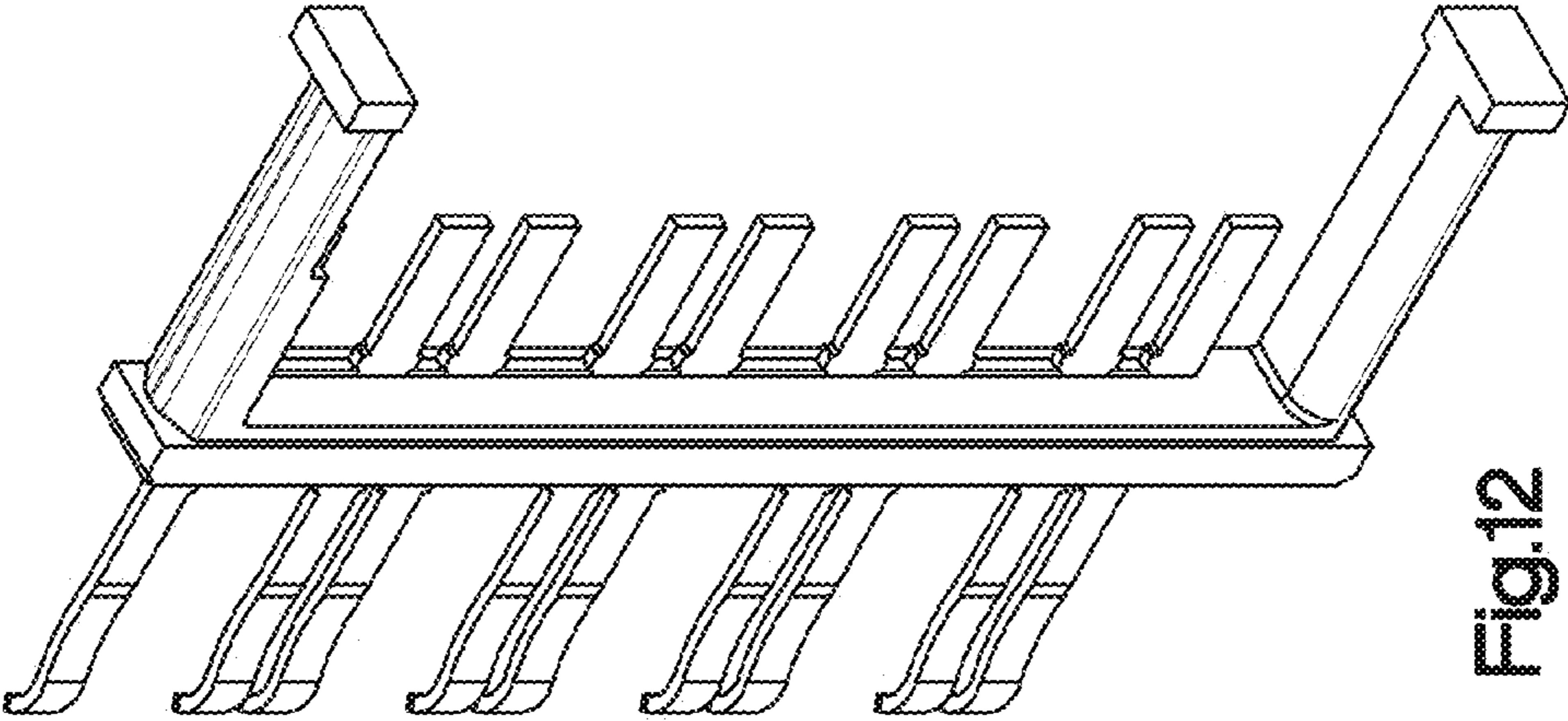


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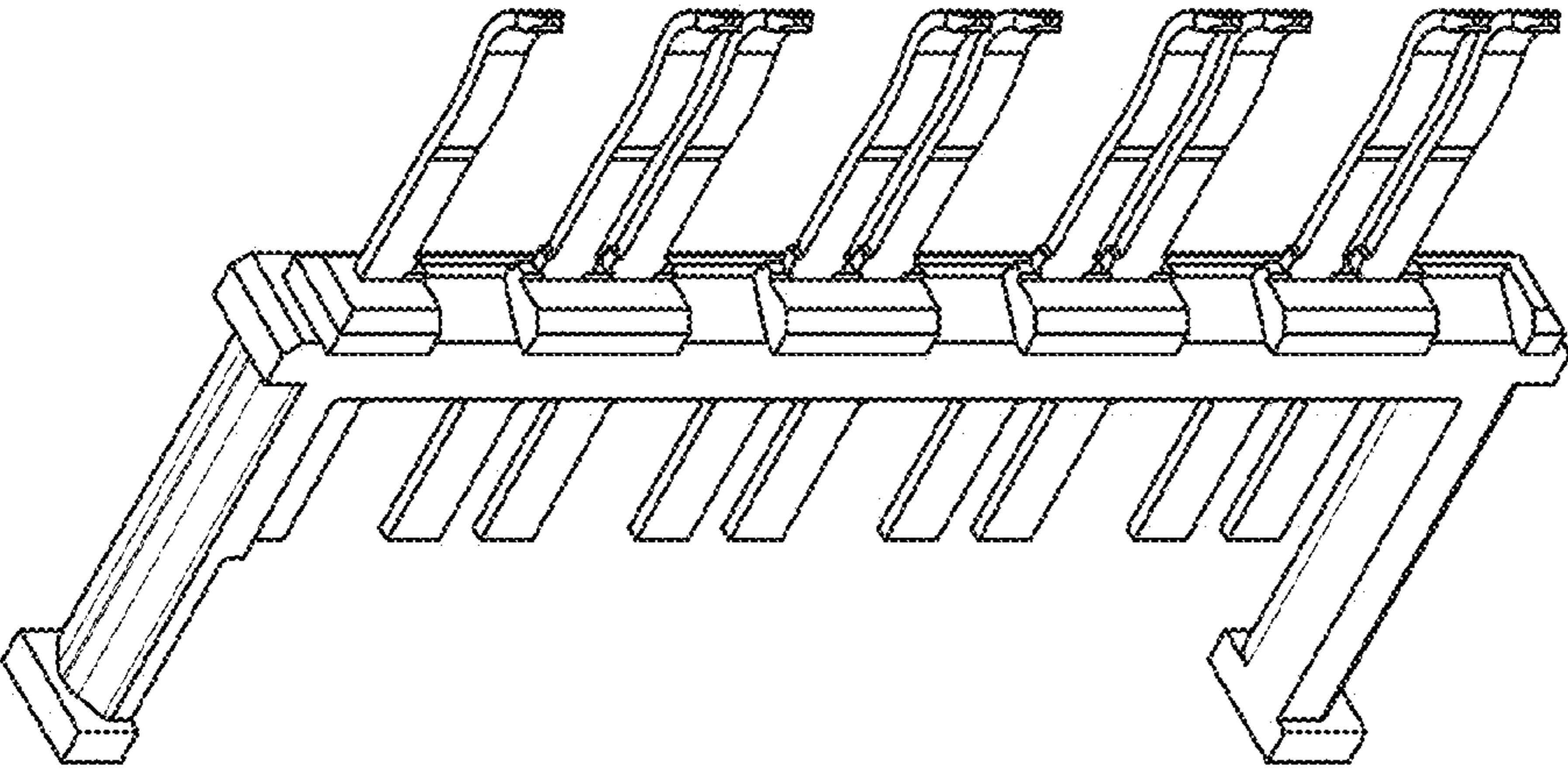


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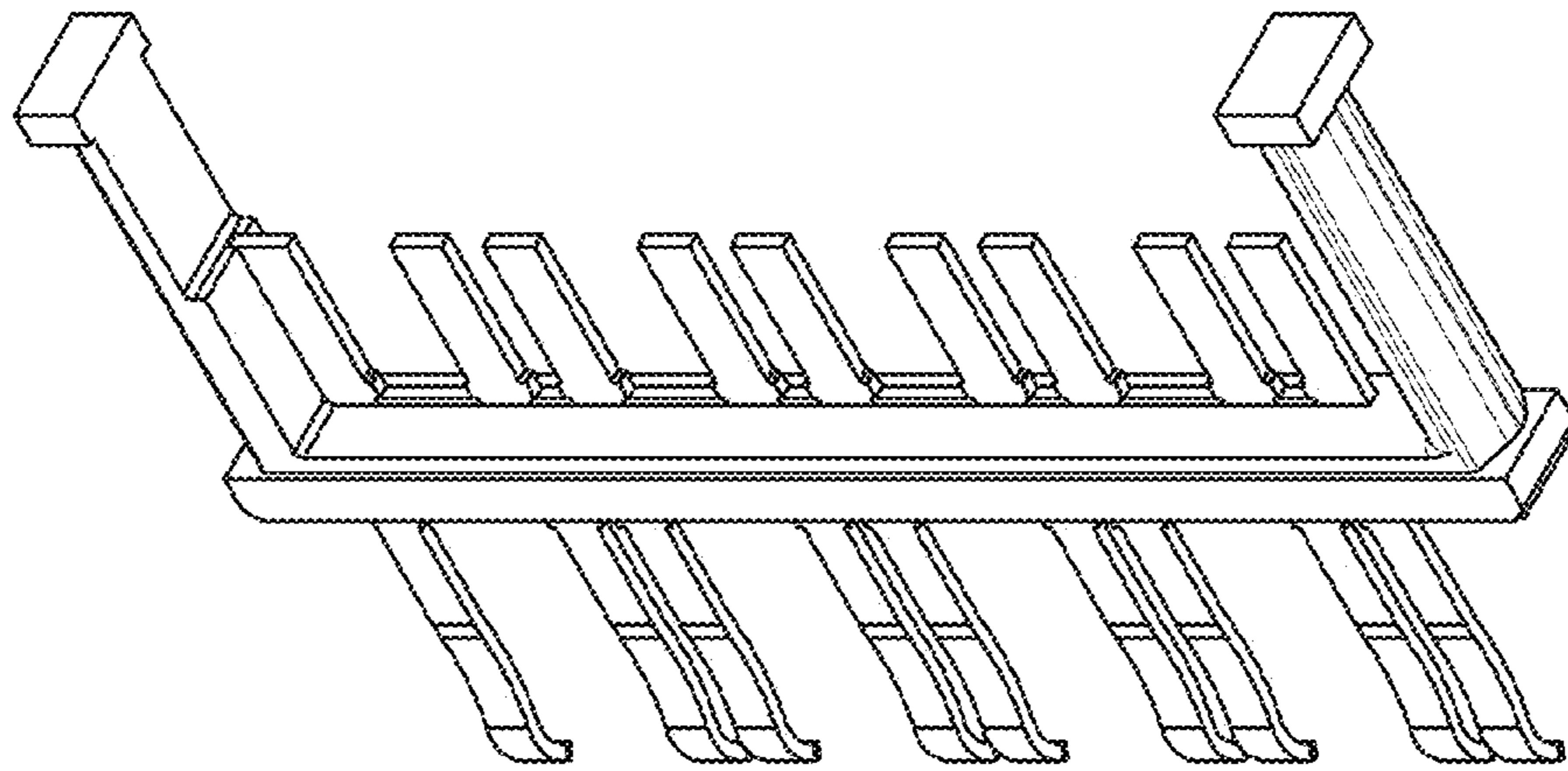


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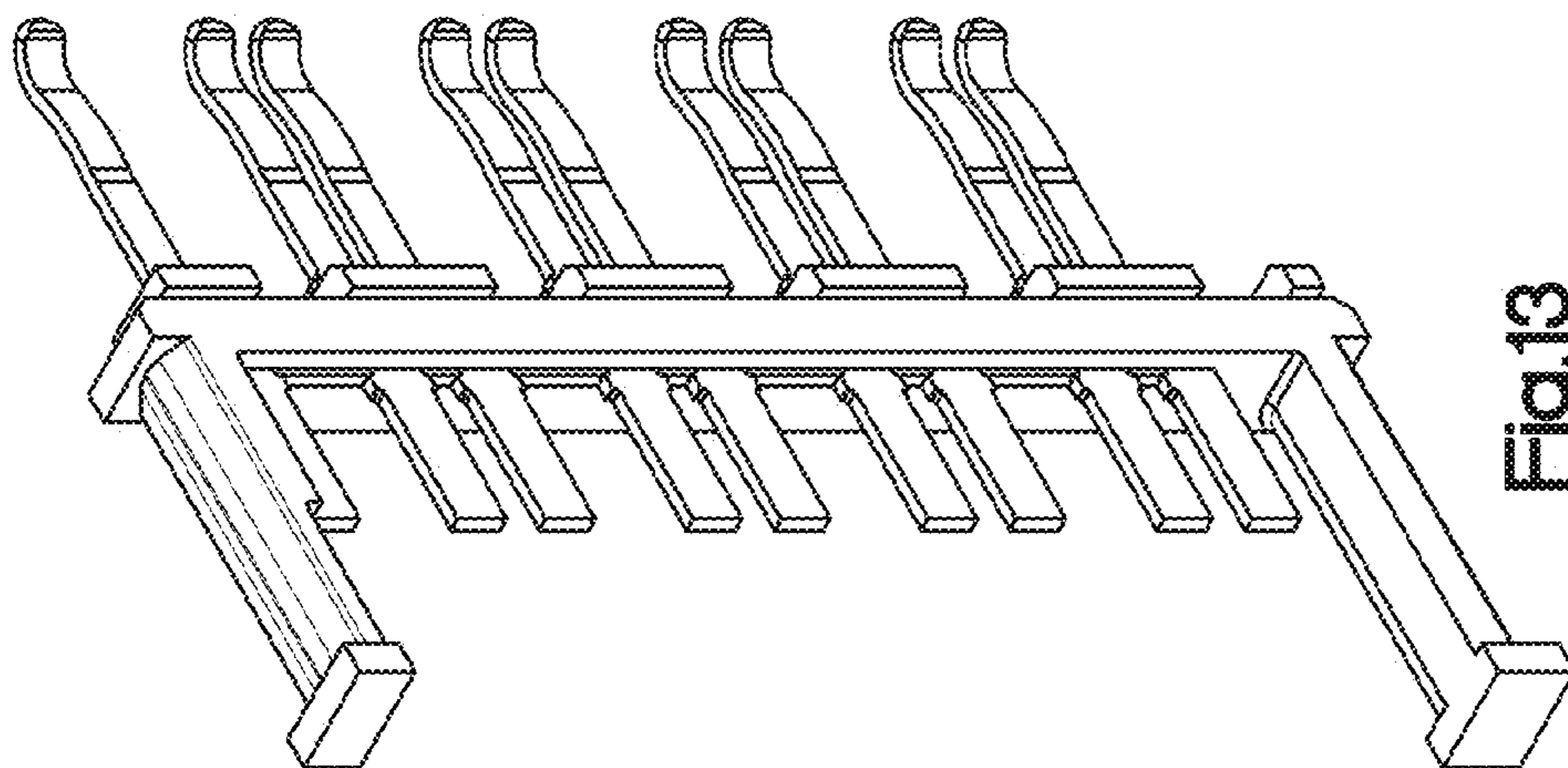


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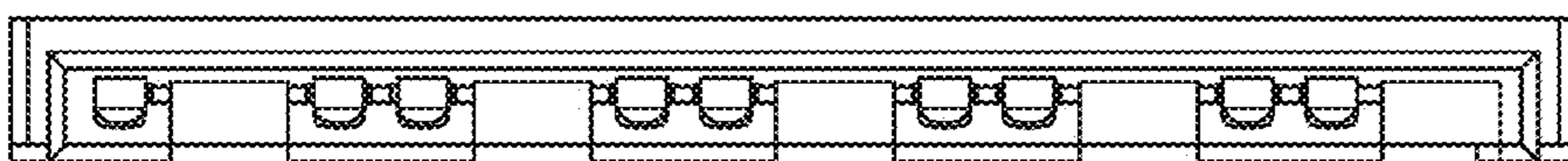


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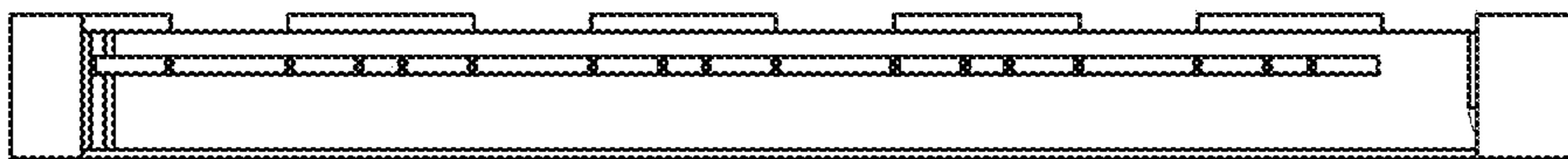


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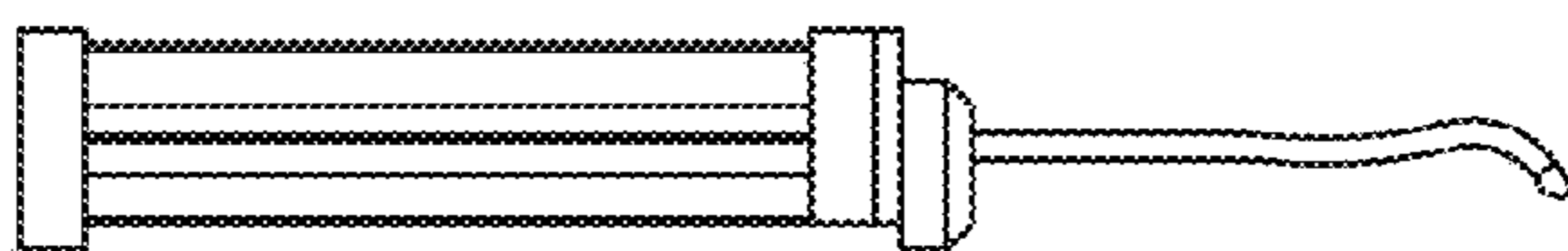


Fig.17

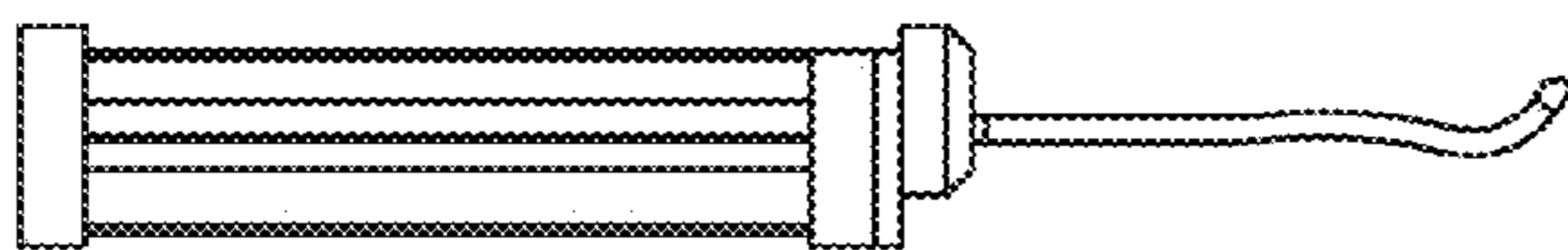


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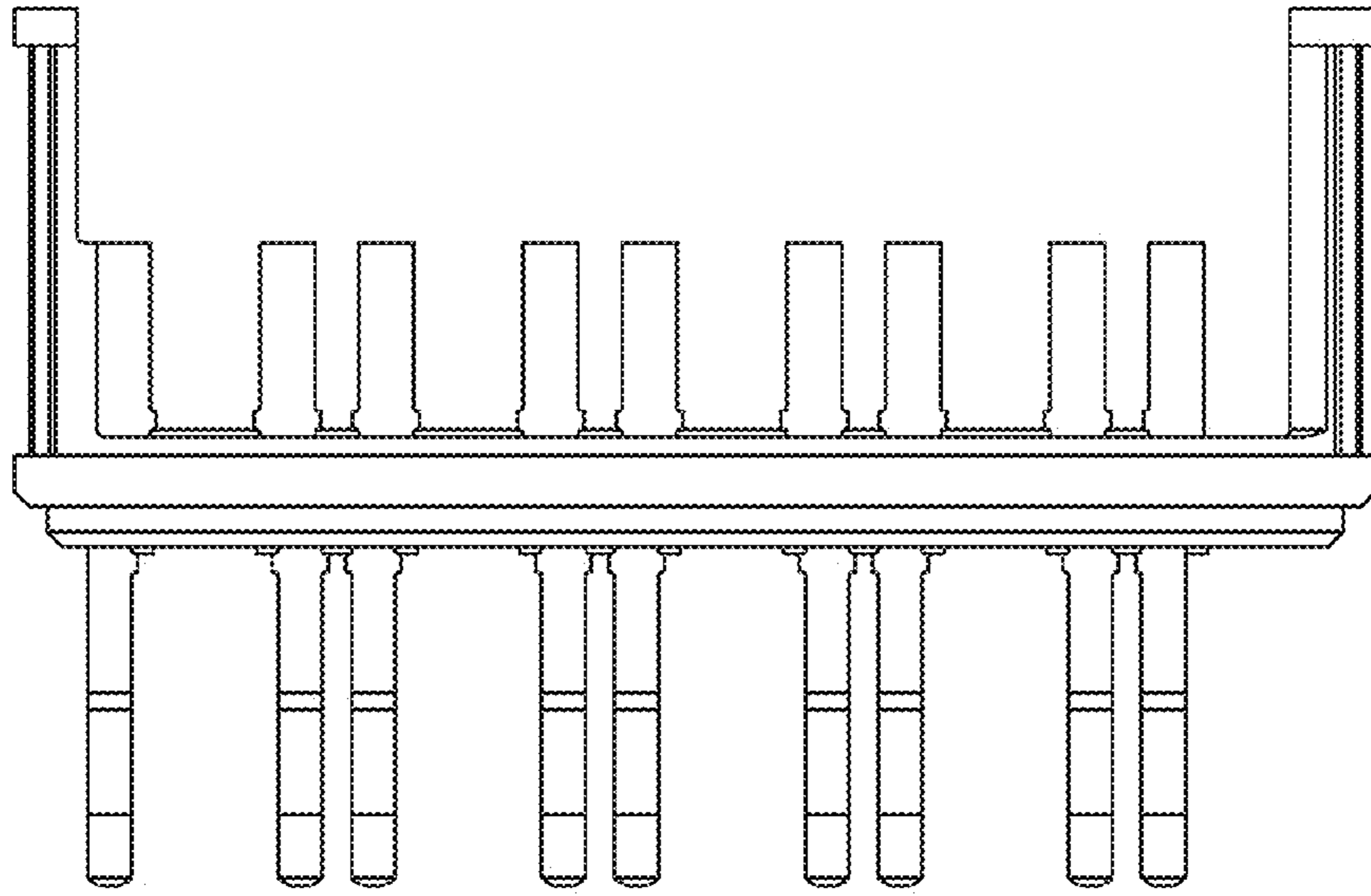


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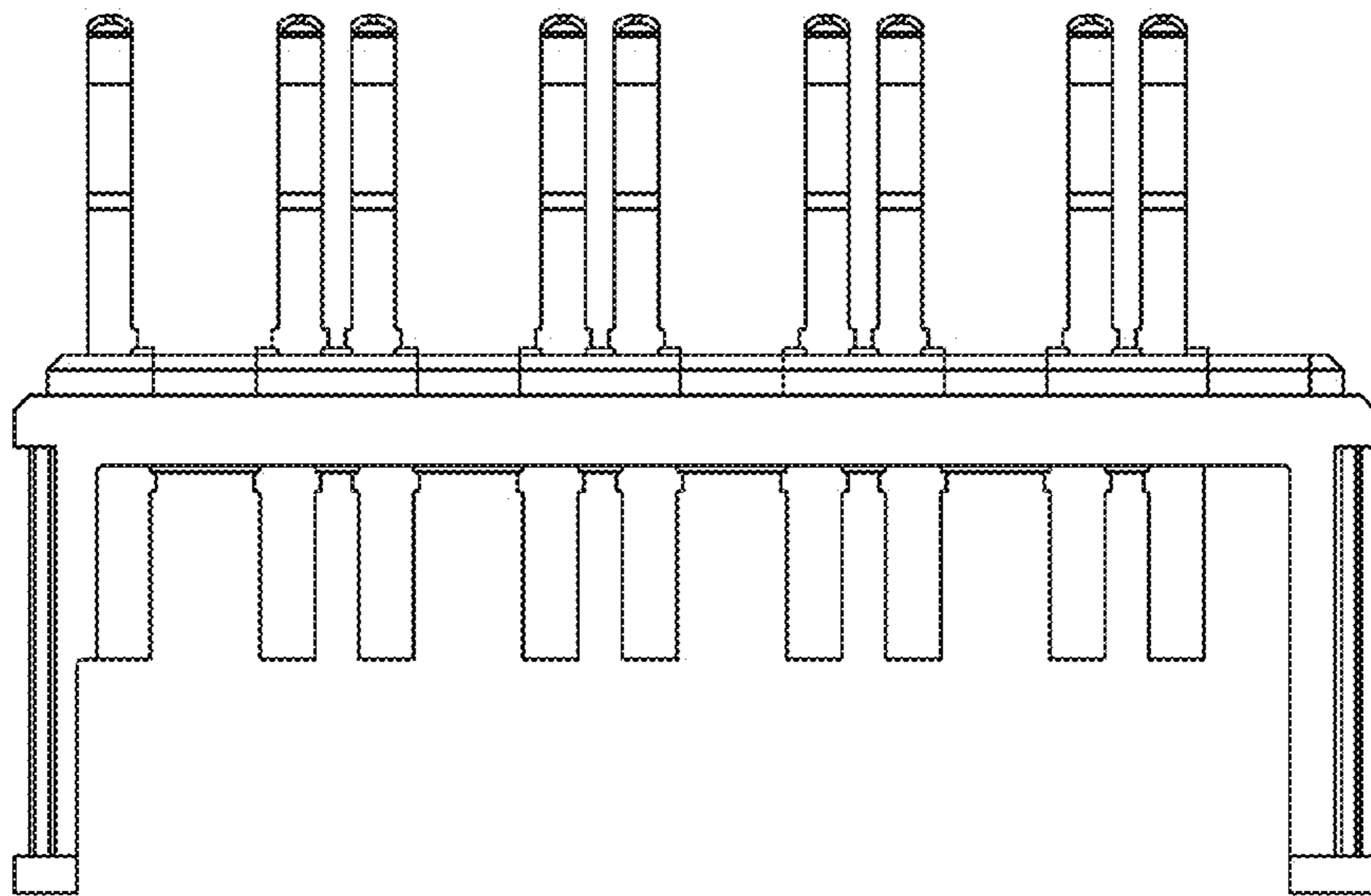


Fig.19